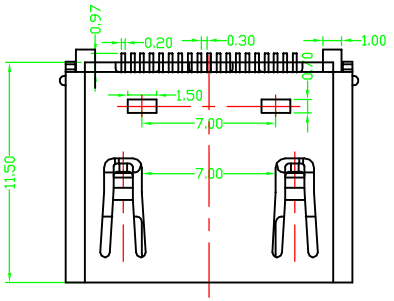
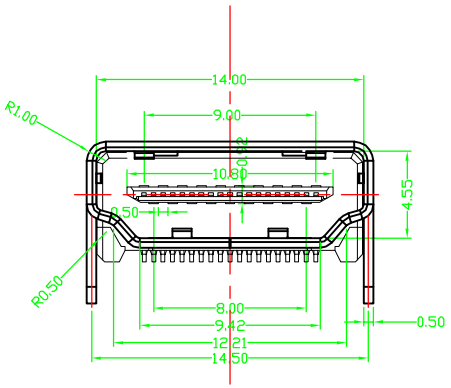
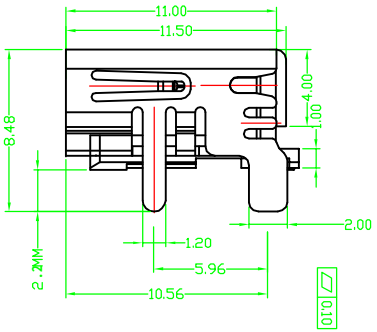
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仅用于评估。

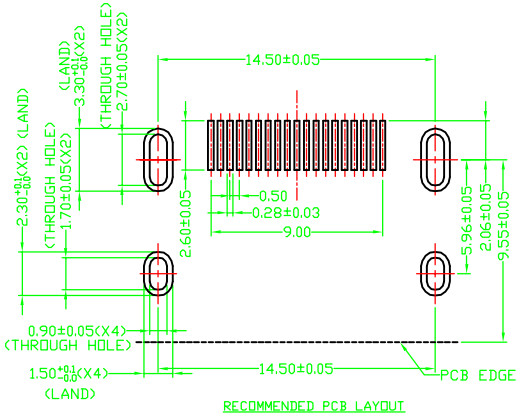


NOTES:

1. MATERIAL:
   1.1 HOUSING: HIGH TEMPERATURE THERMOPLASTIC
   1.2 CONTACT: COPPER ALLOY,T=0.20mm
   1.3 SHELL: COPPER ALLOY,T=0.50mm,MATTE SURFACE
2. PLATING:
   2.1 CONTACT:
   1u" GOLD PLATING ON CONTACT AREA AND MATTE TIN 50u" ON SOLDER AREA
   OVER 50u" NICKEL UNDERPLATING
   2.2 SHELL:
   50u" MIN. NICKEL PLATING OVER ALL







RECOMMENDED PCB LAYOUT

版本REV.	更改标记REVISIONNOTE	日期DATE	未注公差 TOLERANCE		浙江创都电子科技有限公司
			X. ±0.30	X.° ±1°	
			X.X ±0.20	X.X°±0.5°	
			X.XX ±0.10		PART NO：
			X.XXX ±0.05		CAX-HDMI-19P-02FAU
绘制DRAWN			视图方法 PROJECTION		
设计DES'D					版本 A0
审核CHK'D					
批准APPV'D			比例SCALE: 1.5:1	单位UNIT: mm	页码SHEET: 共1页 第1页